Wincomm Edge AI Ready Solution



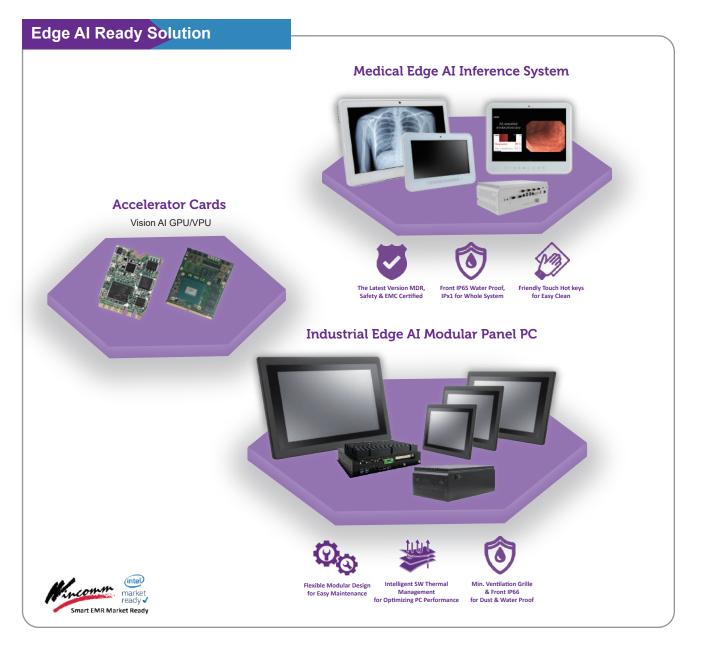
Wincomm Edge AI ePlatform





Forseeing the trend of AI in all fields of applications, such as smart hospitals, intelligent medical image processing to assisted diagnostic surgery, intelligent industrial automation, smart building and so on. There are many advantages that can be realized through the use of AIoT and AIoMT. In its most basic form, it simplifies the performing tasks that are typically done by humans. And those tasks are carried out significantly faster and cost saving in longterm usage.

Wincomm has well experienced on building the e-Platform to integrate with AI ready accelerator cards versus SW tool kits and makes it an ideal edge AI inference computing to speed up your solution toward more efficient while lower down overall ownership in the long term usage. With edge AI ready design, Wincomm provides versatile product combinations for your options, such as GPU, Intel[®] VPU acceleration cards, and these solutions are well integrated plus fully customization service to fulfill your end-to-end solution. Within years, our integration design has been proved as a valuable computing platform and these AI ready solutions are now ready to secure and expand your future business.



Successful Case

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Edge AI Medical Grade Ready for Endoscopy Diagnostic



Patients need better and faster care, doctors need techniques that are trustworthy, and hospitals and administrators need tools that are cost effective. Medical AI can answer all of these needs.

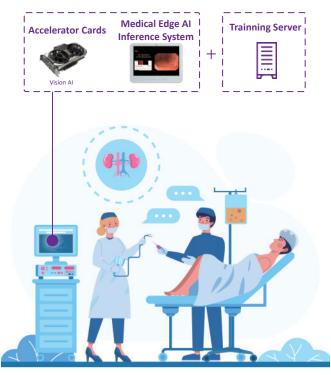
To make such a technology operate properly, different disciplines must work together. One such case is where the engineers at Wincomm worked closely with the team at CYBER-NET SYSTEMS CO., LTD. to develop the EndoBRAIN and EndoBRAIN-EYE tools that deploy AI to detect and analyze colorectal polyps and other lesions in an endoscopy. That HW/SW solution integration is deployed on Wincomm's WMP-K series of panel PCs. EndoBRAIN and EndoBRAIN-EYE were recently approved for use by the PMDA (Pharmaceuticals and Medical Devices Agency), a regulatory body in Japan.

Wincomm Medical AI Panel PC meets or exceeds all of these medical grade certification, and this WMP-K series are featured with an independent GTX1060 graphic card with 6 Gbytes of dedicated video memory, and an extra PCIe expansion slot to suit for complex imaging and AI applications.

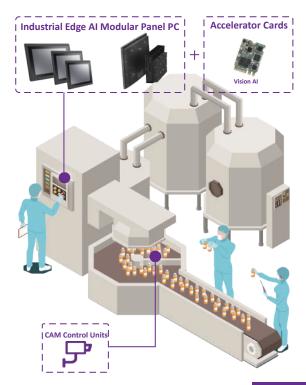
Edge AI Equipped HMI for Food Processing Control

Since manufacturing products defects may cause effects to customer, or affect production efficiency, it is necessary to detect defects on the quality control of the product appearance. With AI inference machine, factory will arise the accuracy to classify defects, cut the cost and reduce errors by human daily reviewing work. Featuring flexible modularization panel versus box pc combination, WLPM-900 series are designed with docking structure and make it easy to maintain and reconfigure to sustain rapid change IIOT environment in a lower cost of overall ownership.

Wincomm Industrial AI Solution modular panel pc WLPM-900 series equipped with Intel[®] Core i processors and independent AI card, are ready to empower AI assisted performing in smart factory. To maintain high computing performance with fanless design, it is designed leveraged our own excellent smart thermal management by designing BIOS to control the CPU core speed away from overheating.



Smart Hygiene Control Market Ready ✓



Leading AIOMT & AIOT for Medical and Industrial Environments, Wincomm offers a wide range of HMI panel PC, BOX PC from medical grade to industrial grade to suit for artificial intelligent solutions in all kinds of applications.

		Madical David DC				Bastin	
	Medical Panel PC					Medical Box PC	
			WMP series			WPC	series
Product Name	15C	22Н	19K	22K (by project)	24K	766	766E
Vlodel							
			Main System				
CPU	Intel [®] Skylake/ Kaby Lake Core i5/i7	Intel® Kaby Lake Core i5/i7	Intel [®] Coffee Lake Refresh Core i5/i7		Intel® Skylake Core i5/i7	Intel® Skylake Core i5/i7	
Graphic	Intel® integrated HD Graphics	Intel [®] integrated HD Graphics Optional GPU MXM3.1 Type A GTX-1050	Intel® integrated HD Graphics Optional GPU MXM3.1 Type B GTX-1060 / RTX-2060			Intel [®] integrated HD Graphics 530	
Memory	up to 32G	up to 32G		up to 64G		up to 32G	up to 32G
Chipset	Soc	Intel® Q170		Intel® Q370		Intel® Q170	Intel® Q170
OS support	Win7 /Win8 / Win10	Win10	Dial	Win10		Win7 /Win8 / Win10	Win7 /Win8 / Win1
lize	15.0"	21 5"	Display	21 5"	22.0"		
iize Resolution	15.6" 1366 x 768 (SXGA)	21.5" 1920 x 1080 (FHD)	19" 1280 x 1024 (SXGA),	21.5" 1920 x 1080 (FHD)	23.8" 1920 x 1080 (FHD)	-	
Color Numbers	1366 X 768 (SXGA) 16.7M	1920 X 1080 (FHD) 16.7M	1280 x 1024 (SXGA), 16.7M	1920 X 1080 (FHD) 16.7M	1920 X 1080 (FHD) 16.7M	-	
/iew Angle (H/V)	170/160	178/178	170/160	178/178	178/178	-	_
Contrast	500:1	3000:1	1000:1	3000:1	3000:1	-	
Brightness (nits)	400	250	350	250	250		
			Touch Panel & IO				
Гуре	Full Flat P.cap Touch	Full Flat P.cap Touch	Full Flat P.cap Touch			-	_
JSB	USB 3.0 x 4	USB 3.0 x 4	USB 3.1 gen II x 4			USB 3.0 x 4	USB 3.0 x 4
СОМ	RS232 x 1 RS232/RS422/RS485 X 1	RS232 x 1 RS232/RS422/RS485 X 1	RS232 x 1 RS232/RS422/RS485 X 1		RS232 x 5, RS232/422/485 x 1	RS232 x 5, RS232/422/485 x 1	
LAN	RJ45 x 2	RJ45 x 2	RJ45 x 2			RJ45 x 2	RJ45 x 2
Audio			3.5mm phone jack connector * 2 (Mic-In, Line-Out)				
Video	DP x 2	DP x 2	DP x 2		DP x 1 DVI-D x 1	DP x 1 DVI-D x 1	
Stores	500C UDD		Storage & Expansion 128G SSD		C4C 55D	(4C 55D	
Storage	500G HDD PCI-E*4 x 1 Mini PCIe x 1 M.2 Type E key x 1	128G SSD PCI-E*4 x 1 Mini PCIe x 1 M.2 Type E key x 1	PCI-E*4 x 1 M.2 Type E key x 1		64G SSD Mini PCle x 2	64G SSD PCI-E*16 x 1 Mini PCIe x 2	
		Mec	chanical & Environme				
Weight (kg)	5.0	7.5	7.5	TBD	9.0	3.0	4.0
Operating Temp.	0~35°C	0~40°C	0~40°C	0~40°C	0~40°C	0~35°C	0~35°C
Cooling	Fanless IP65 at front side/ IPx1	Fan		Fan		Fanless	Fanless
IP rating	for whole system	IP65 at front side	IP65 at front side/ IPx1 for whole system —			-	
Power Input	DC 9~32V	DC 14~201/	Power	TPD	DC 14~10V	DC 0~29V	DC 0~201/
Power Input Power Adapter/	AC 100~240V	DC 14~28V AC 100~240V /	DC 14~19V	TBD AC 100~240V	DC 14~19V	DC 9~28V	DC 9~28V AC 100~240V
Battery	/ UPS Battery	Hot-swappable Battery		/ UPS Battery		AC 100~240V	/ UPS Battery
			Certification				
Certification	FCC: Part 18 Class B UL: ANSI/AAMI ES606 cUL: CAN/CSA-C22.2	06/A1:2013(V3.1) B (PSU/Battery with PSE)	CE: EN 60601-1-2:2015(V4.0), MDR: MDR 2017/745 VCCI: 2016-11, Class B (PSU with PSE), FCC: Part 18 Class B, UL: ANSI/AAMI ES60601-1:2012 (V3.1) cUL: CAN/CSA-C22.2 No. 60601-1:2014 (V3.1) ISO 14971 / IEC62133 / Energy star 6.1 compliance		CE: EN 60601-1-2:2015(V4.0), MDD: EN 60601-1:2006/A1:2013(V3.1) VCCI: 2016-11, Class B (PSU/Battery with PSE FCC: Part 18 Class B UL: ANSI/AAMI ES60601-1:2012 (V3.1) cUL: CAN/CSA-C22.2 No. 60601-1:2014 (V3.1) ISO 14971 / IEC62133 / Energy star 6.1 compliance		

Product Selection Guide

Edge Al Modular Panel PC Platform

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		WLP Pane	l PC Series		
			WLPM- 900		
Product Name	915	917	919	922	924
Model					
			System		
CPU	In	tel [®] 9th Gen Coffee Lake-S (Core i7/i5/i3 Processors, 2.2~3	3.6GHz, 35W, w/ Q370 Chipse	et
Graphic			Intel [®] UHD Graphics 630		
Memory		Dual Channel Su	pport 2666MHz DDR4 SODIM	M X2, up to 32GB	
OS support			Win 10 (64 bit)		
			play		
Size	15" 4:3	17" 4:3	19" 4:3	21.5" 16:9	23.8"16:9
Resolution	1024 x 768 (XGA)	1280 x 1024 (SXGA)	1280 x 1024 (SXGA)	1920 x 1080 (FHD)	1920 x 1080 (FHD)
Color Numbers	16.7M	16.2M	16.7M	16.7M	16.7M
View Angle (H/V)	160/160	170/160	170/160	170/160	178/178
Contrast	800:1	1000:1	1000:1	1000:1	3000:1
Brightness (nits)	450	350	350	250	250
		Touch Pa	anel & IO		
Туре	Full Flat R-Touch (Default) P-Cap Touch P-Cap Touch (Option) P-Cap Touch			P-Cap Touch	
ю	4 x USB3.1, 2x RS232, 1 x RS232/RS422/RS485, 2 x RJ-45, 2 x 3.5mm phone jack connector(Line-out, Mic-in), 3 x DP1.2				
		Storage &	Expansion		
Storage	1 x 2.5" SATA HDD 1 x M.2 M.Key 2280 PClex4 for NVMe SSD				
Expansion slot	1 x M.2 Key E 2230 w/ PClex1, USB2.0 and CNVI for Wireless 1 x mini-PCle for Full/Half w/ PClex1 and USB2.0 1 x PClex16 (25W max.)				
		Mechanical &	Environmental		
Operating Temp.	Operation: 19V DC Input 0~50°C				
IP rating	IP66 Front				
Cooling	Fanless				
		Ро	wer		
Power Input	DC19~28V				
Power Adapter	150W (PSU with PSE)				
	Certification				
Certification	CE / FCC / VCCI Class B				

Accelerator Cards

GPU	GTX-1050	GTX-1050 GTX-1060		
Model			1009	
IC	NVIDIA CUDA® Cores			
Form Factor	PCIe 3.0 PCIe 3.0 PCIe 3.0		PCIe 3.0	
Operation Temp.	Up to 97°C	Up to 94°C	Up to 97°C	
OS Support	Win 7-10 Linux	Win 7-10 Linux Free BSP X86	Win 7-10 Linux	
Others (Embedded Memory) Up to 4GB		Up to 6GB	Up to 6GB	

VPU	VEGA-320	Al Core-X	Al Core-XP4/XP8		
Model					
IC	Intel [®] Movidius Myriad X VPU				
	VPU x 1	VPU x 1	VPU x 4, VPU x 8		
Form Factor	M.2	Mini PCIe	PCIe x 4 (Full Length)		
Operation Temp.	-20-60°C	0-60°C	0-50°C		
OS Support	Windows® 10 Ubuntu 16.04 Centos 7.4	Windows® 10 Ubuntu 16.04	Windows® 10 Ubuntu 16.04		
Others (Support Framwork)	TensorFlow, Caffe, MXNET				

Headquarters	3F, No. 14, Prosperity Road II, Science-Based Industrial Park, Hsinchu, Taiwan, R.O.C.		
	Tel +886 3 578 0000		
	Fax +886 3 577 0631		
	sales_support@wincomm.com.tw		
Wincomm USA	2138 Ringwood Avenue,San Jose, CA 95131 USA sales_support@wincomm.com.tw		
Wincomm Japan	#206, 4-16-17, Namiki, Kawaguchi-City, Saitama, 332-0034, Japan sales_support@wincomm.com.tw		





Wincomm is one of Taiwan's leading manufacturer of industrial computer and embedded computer products. Wincomm designs and develops all in one panel PC, rugged box PC and embedded software products for a broad range of industries and applications.

Wincomm aims to provide hardware and software integrated solutions for the most variant environments such as industrial automation/ human machine interface control, digital signage / infotainment Kiosk, and medical computing.